



ISO 3795 (FMVSS 302)

# Rynite® 530HTE BK503

## THERMOPLASTIC POLYESTER RESIN

Rynite\$ 530HTE BK503 is a 30% glass reinforced modified polyethylene terephthalate resin with excellent high temperature dielectric properties

Product information			
Resin Identification	PET-GF30		ISO 1043
Part Marking Code	>PET-GF30<		ISO 11469
Rheological properties			
Moulding shrinkage, parallel	0.1	%	ISO 294-4, 2577
Moulding shrinkage, normal	0.6		ISO 294-4, 2577
Postmoulding shrinkage, normal, 48h at 80°C	0.45		ISO 294-4
Postmoulding shrinkage, parallel, 48h at 80°C	0.1		ISO 294-4
Typical mechanical properties			
Tensile modulus	11000	MPa	ISO 527-1/-2
Tensile modulus Tensile stress at break, 5mm/min		MPa	ISO 527-1/-2
Tensile strain at break, 5mm/min	1.9		ISO 527-1/-2
Compressive strength		MPa	ISO 604
Charpy impact strength, 23°C	42	kJ/m²	ISO 179/1eU
Charpy notched impact strength, 23°C	8.9	kJ/m²	ISO 179/1eA
Hardness, Rockwell, R-scale	120		ISO 2039-2
Ball indentation hardness, H 961/30		MPa	ISO 2039-1
Poisson's ratio	0.34		
Thermal properties			
Melting temperature, 10 ° C/min	252	°C	ISO 11357-1/-3
Glass transition temperature, 10°C/min	90	°C	ISO 11357-1/-3
Temperature of deflection under load, 1.8 MPa	230	°C	ISO 75-1/-2
Temperature of deflection under load, 0.45 MPa	251	-	ISO 75-1/-2
Thermal conductivity, flow	0.29	W/(m K)	ISO 22007-2
Flammability			
Glow Wire Flammability Index, 3.0mm	800	°C	IEC 60695-2-12
Glow Wire Ignition Temperature, 3.0mm	775	°C	IEC 60695-2-13
Glow Wire Temperature, No Flame, 1mm	750	°C	IEC 60335-1
Glow Wire Temperature, No Flame, 1.5mm	750		IEC 60335-1
Glow Wire Temperature, No Flame, 2mm	750		IEC 60335-1
Glow Wire Temperature, No Flame, 3mm	825	°C	IEC 60335-1
FMVSS Class	В	, .	ISO 3795 (FMVSS 302)

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<80 mm/min

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Burning rate, Thickness 1 mm





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#### Electrical properties

Relative permittivity, 100Hz	4.3	IEC 62631-2-1
Relative permittivity, 1MHz	3.8	IEC 62631-2-1
Dissipation factor, 100Hz	18 E-4	IEC 62631-2-1
Dissipation factor, 1MHz	146 E-4	IEC 62631-2-1
Volume resistivity	>1E13 Ohm.m	IEC 62631-3-1
Surface resistivity	1E14 Ohm	IEC 62631-3-2
Electric strength	35 kV/mm	IEC 60243-1
Comparative tracking index	200	IEC 60112
Electric Strength, Short Time, 23°C, 2mm	23 kV/mm	IEC 60243-1

#### Physical/Other properties

Water absorption, Immersion 24h	0.05 %	Sim. to ISO 62
Density	1590 kg/m <sup>3</sup>	ISO 1183

#### **VDA Properties**

Fogging, G-value (condensate) 0 mg ISO 6452

#### Injection

Drying Recommended	yes	
Drying Temperature	120	°C
Drying Time, Dehumidified Dryer	4 - 6	
Processing Moisture Content	≤0.02 <sup>[1]</sup>	%
Melt Temperature Optimum	285	°C
Min. melt temperature	280	°C
Max. melt temperature	300	°C
Screw tangential speed	≤0.2	m/s
Mold Temperature Optimum	140	°C
Min. mould temperature	120	•
Max. mould temperature	140 <sup>[2]</sup>	°C
Hold pressure range	≥80	MPa
Hold pressure time	4	s/mm
Back pressure	As low as	MPa
	possible	
Ejection temperature	170	°C

[1]: At levels above 0.02%, strength and toughness will decrease, even though parts may not exhibit surface defects.

#### Characteristics

Processing Injection Moulding

#### Additional information

Injection molding When lower mold temperatures are used, the initial warpage and shrinkage will

be lower, but the surface appearance will be poorer and the dimensional change

may be greater when parts are subsequently heated.

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<sup>[2]: (6</sup>mm - 1mm thickness)

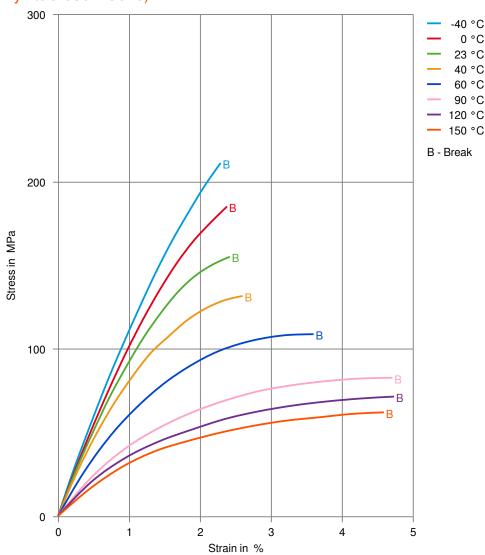




# Rynite<sup>®</sup> 530HTE BK503

### THERMOPLASTIC POLYESTER RESIN

Stress-strain (measured on Rynite® 530 NC010)



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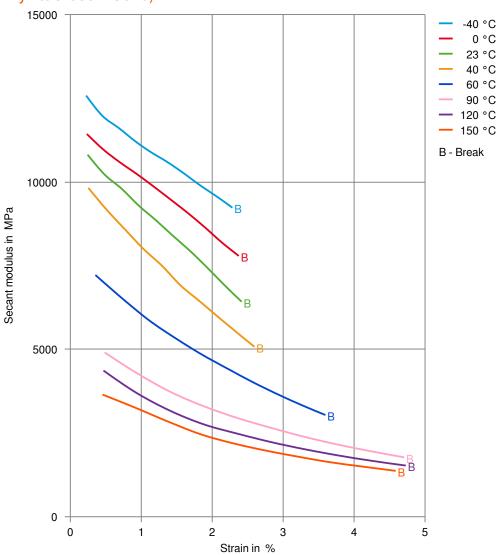




## Rynite® 530HTE BK503

#### THERMOPLASTIC POLYESTER RESIN

Secant modulus-strain (measured on Rynite® 530 NC010)



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